

SID

Factory: Rot am See

Article:

ML8

Provided:

Customer:

Date:

03.04.2026

WÜRTH  
ELEKTRONIK  
MORE THAN  
YOU EXPECT

Processtechnology: B: undefined

Material Text	Mat. Nr.	µm	Stackup	Process overview
A-RS Kupferfolie-070my 330x490mm	50200246	70	VS	1
C-RAS-FR4-PP-7628-TG150HF-gel-PAN-R15...	50202586	325		2
C-RAS-FR4-PP-2116_H50-TG150HF-gel-PAN...	50202536	0		3
C-RAS-FR4-PP-1080-TG150HF-PAN-R1551...	50202535	0		4
C-RAS-ML-0.15-105+105-460x305-TG150HF-...	50202557	105	L2	5
		150		
		105	L3	
C-RAS-FR4-PP-1080-TG150HF-PAN-R1551...	50202535	230		6
C-RAS-FR4-PP-7628-TG150HF-gel-PAN-R15...	50202586	0		7
C-RAS-FR4-PP-1080-TG150HF-PAN-R1551...	50202535	0		8
C-RAS-ML-0.15-105+105-460x305-TG150HF-...	50202557	105	L4	9
		150		
		105	L5	
C-RAS-FR4-PP-1080-TG150HF-PAN-R1551...	50202535	230		10
C-RAS-FR4-PP-7628-TG150HF-gel-PAN-R15...	50202586	0		11
C-RAS-FR4-PP-1080-TG150HF-PAN-R1551...	50202535	0		12
C-RAS-ML-0.15-105+105-460x305-TG150HF-...	50202557	105	L6	13
		150		
		105	L7	
C-RAS-FR4-PP-1080-TG150HF-PAN-R1551...	50202535	325		14
C-RAS-FR4-PP-2116_H50-TG150HF-gel-PAN...	50202536	0		15
C-RAS-FR4-PP-7628-TG150HF-gel-PAN-R15...	50202586	0		16
A-RS Kupferfolie-070my 330x490mm	50200246	70	RS	17

Thickness after Pressing

B00:

2290 µm

Tol+:

240 µm

Tol-:

240 µm

Dmax:

2530 µm

Dmin:

2050 µm

Thickness over all

0 µm

Tol+:

0 µm

Tol-:

0 µm

Dmax:

0 µm

Dmin:

0 µm

Demand for customer

Thickness (D):

2400 µm

Tol+:

240 µm

Tol-:

240 µm

Dmax:

2640 µm

Dmin:

2160 µm

Measuring point: (05) over SM and galv. Cu; both sides

nominal:

2330 µm

Version 1.2.20.35

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